

HALOGEN

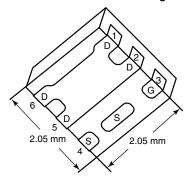


Vishay Siliconix

P-Channel 20 V (D-S) MOSFET

PRODUCT SUMMARY								
V _{DS} (V)	$R_{DS(on)}$ (Ω) Max.	I _D (A)	Q _g (Typ.)					
- 20	$0.0165 \text{ at V}_{GS} = -4.5 \text{ V}$	- 12 ^a						
	$0.0185 \text{ at V}_{GS} = -3.7 \text{ V}$	- 12 ^a	23 nC					
	0.0300 at $V_{GS} = -2.5 \text{ V}$	- 12 ^a						

PowerPAK SC-70-6L-Single



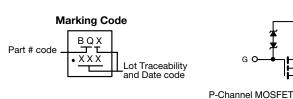
Ordering Information: SiA445EDJ-T1-GE3 (Lead (Pb)-free and Halogen-free)

FEATURES

- Halogen-free According to IEC 61249-2-21 **Definition**
- TrenchFET® Power MOSFET
- Thermally Enhanced PowerPAK® SC-70 Package
 - Small Footprint Area
 - Low On-Resistance
- 100 % $\rm R_{\rm g}$ Tested Built in ESD Protection with Zener Diode
- Typical ESD Performance: 2000 V
- Compliant to RoHS Directive 2002/95/EC

APPLICATIONS

- Smart Phones, Tablet PCs, Mobile Computing
 - Battery Switch
 - Charger Switch
 - Load Switch



ABSOLUTE MAXIMUM RATINGS (T _A = 25 °C, unless otherwise noted)								
Parameter		Symbol	Limit	Unit				
Drain-Source Voltage		V_{DS}	- 20	V				
Gate-Source Voltage		V _{GS}	± 12	V				
	T _C = 25 °C	- I _D	- 12 ^a					
Continuous Drain Current (T _{.1} = 150 °C)	T _C = 70 °C		- 12 ^a					
Continuous Diain Current (1) = 130 C)	T _A = 25 °C		- 11.8 ^{b, c}					
	T _A = 70 °C		- 9.5 ^{b, c}	Α				
Pulsed Drain Current (t = 300 μs)		I _{DM}	- 50					
Continuous Source-Drain Diode Current	T _C = 25 °C	l _a	- 12 ^a					
Continuous Source-Diam Diode Current	T _A = 25 °C	I _S	- 2.9 ^{b, c}					
	T _C = 25 °C		19					
Maximum Power Dissipation	T _C = 70 °C	P _D	12	W				
Maximum Fower Dissipation	T _A = 25 °C	L LD	3.5 ^{b, c}	VV				
	T _A = 70 °C		2.2 ^{b, c}					
Operating Junction and Storage Temperature Ra	ange	T _J , T _{stg}	- 55 to 150	°C				
Soldering Recommendations (Peak Temperature	e) ^{d, e}		260	O				

THERMAL RESISTANCE RATINGS									
Parameter		Symbol	Typical	Maximum	Unit				
Maximum Junction-to-Ambient ^{b, f}	t ≤ 5 s	R _{thJA}	28	36	°C/W				
Maximum Junction-to-Case (Drain)	Steady State	R_{thJC}			0/ **				

Notes:

- a. Package limited.
- b. Surface mounted on 1" x 1" FR4 board.
- d. See solder profile (www.vishay.com/doc?73257). The PowerPAK SC-70 is a leadless package. The end of the lead terminal is exposed copper (not plated) as a result of the singulation process in manufacturing. A solder fillet at the exposed copper tip cannot be guaranteed and is not required to ensure adequate bottom side solder interconnection.
- e. Rework conditions: manual soldering with a soldering iron is not recommended for leadless components.
- f. Maximum under steady state conditions is 80 °C/W.

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Parameter	Symbol	Test Conditions	Min.	Typ.	Max.	Unit		
Static								
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_{D} = -250 \mu\text{A}$	- 20			V		
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$			- 13				
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	I _D = - 250 μA		2.6		mV/°C		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_{D} = -250 \mu A$	- 0.5		- 1.2	V		
		$V_{DS} = 0 \text{ V}, V_{GS} = \pm 12 \text{ V}$			± 60			
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 4.5 \text{ V}$			± 1	μΑ		
		V _{DS} = - 20 V, V _{GS} = 0 V			- 1			
Zero Gate Voltage Drain Current	IDSS	$V_{DS} = -20 \text{ V}, V_{GS} = 0 \text{ V}, T_{J} = 55 \text{ °C}$			- 10			
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \le -5 \text{ V}, V_{GS} = -4.5 \text{ V}$	- 20			Α		
		V _{GS} = - 4.5 V, I _D = - 7 A		0.0135	0.0165	Ω		
Drain-Source On-State Resistance ^a	R _{DS(on)}	V _{GS} = - 3.7 V, I _D = - 5 A		0.0150	0.0185			
		V _{GS} = - 2.5 V, I _D = - 5 A		0.0210	0.0300	−		
Forward Transconductance ^a	9 _{fs}	V _{DS} = - 10 V, I _D = - 7 A		29		S		
Dynamic ^b	0.0	39 2						
Input Capacitance	C _{iss}			2130		pF		
Output Capacitance	C _{oss}	V _{DS} = - 10 V, V _{GS} = 0 V, f = 1 MHz		290				
Reverse Transfer Capacitance	C _{rss}	25		280				
Total Gate Charge		V _{DS} = - 10 V, V _{GS} = - 10 V, I _D = - 12 A		48	72	nC		
<u> </u>	Q_g	56 7 G6 7 B		23	35			
Gate-Source Charge	Q _{gs}	V _{DS} = - 10 V, V _{GS} = - 4.5 V, I _D = - 12 A		3.1				
Gate-Drain Charge	Q _{gd}			6.7				
Gate Resistance	R _g	f = 1 MHz	1.2	6	12	Ω		
Turn-On Delay Time	t _{d(on)}			25	50			
Rise Time	t _r	$V_{DD} = -10 \text{ V}, R_1 = 1 \Omega$		25	50			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -9.5 \text{ A}, V_{GEN} = -4.5 \text{ V}, R_g = 1 \Omega$		55	110			
Fall Time	t _f			20	40			
Turn-On Delay Time	t _{d(on)}			7	15	ns		
Rise Time	t _r	V_{DD} = - 10 V, R_L = 1 Ω		10	20			
Turn-Off Delay Time	t _{d(off)}	$I_D \cong -9.5 \text{ A}, V_{GEN} = -10 \text{ V}, R_g = 1 \Omega$		60	120			
Fall Time	t _f			17	35			
Drain-Source Body Diode Characterist	ics				l			
Continuous Source-Drain Diode Current	I _S	T _C = 25 °C			- 12			
Pulse Diode Forward Current	I _{SM}				- 50	A		
Body Diode Voltage	V _{SD}	I _S = - 9.5 A, V _{GS} = 0 V		- 0.8	- 1.2	V		
Body Diode Reverse Recovery Time	t _{rr}			15	30	ns		
Body Diode Reverse Recovery Charge	Q _{rr}	I _F = - 9.5 A, dI/dt = 100 A/μs,		5	10	nC		
Reverse Recovery Fall Time	t _a	T _J = 25 °C		7				
Reverse Recovery Rise Time	t _b			8		ns		

Notes:

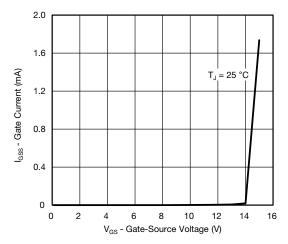
- a. Pulse test; pulse width $\leq 300~\mu s,$ duty cycle $\leq 2~\%.$
- b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

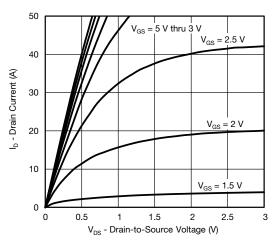


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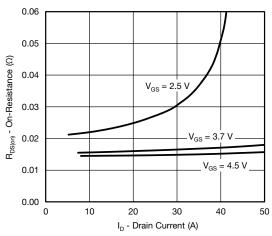
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



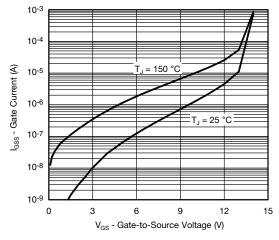
Gate Current vs. Gate-Source Voltage



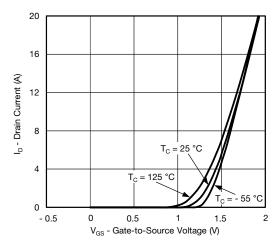
Output Characteristics



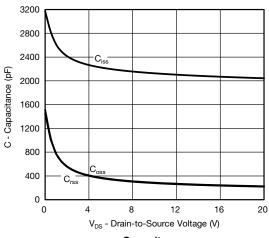
On-Resistance vs. Drain Current



Gate Current vs. Gate-Source Voltage



Transfer Characteristics

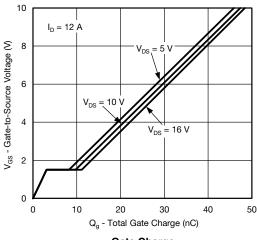


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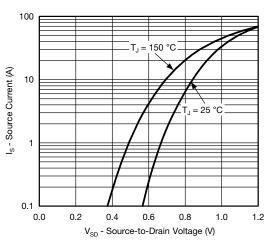
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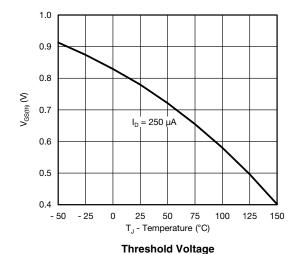
TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Gate Charge

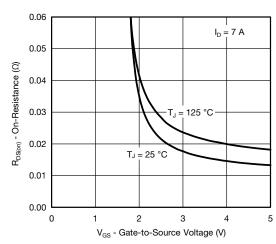


Soure-Drain Diode Forward Voltage

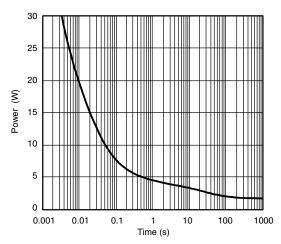


1.5 1.4 R_{DS(on)} - On-Resistance (Normalized) $V_{GS} = 2.5 V$ 1.3 1.2 1.1 1.0 0.9 0.8 0.7 - 50 0 25 50 75 125 150 100 T_J - Junction Temperature (°C)

On-Resistance vs. Junction Temperature



On-Resistance vs. Gate-to-Source Voltage

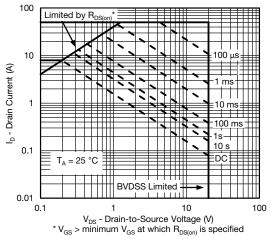


Single Pulse Power, Junction-to-Ambient

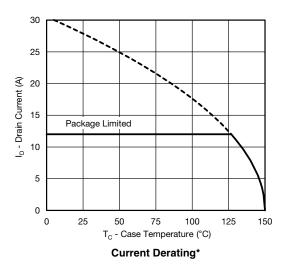


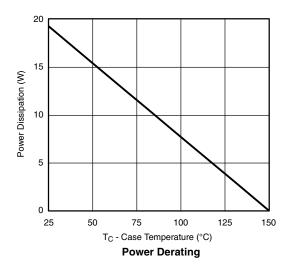
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Safe Operating Area, Junction-to-Ambient





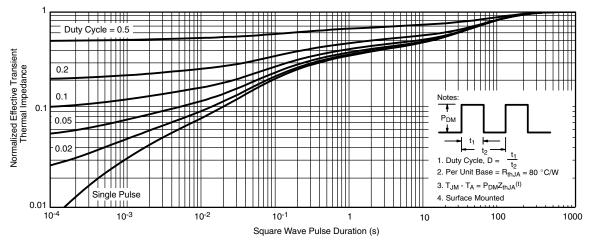
Document Number: 63619 S11-2525-Rev. A, 26-Dec-11

^{*} The power dissipation PD is based on TJ(max) = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

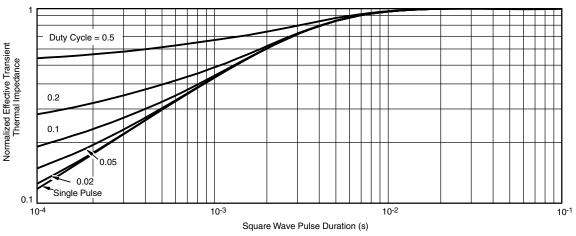
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TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)



Normalized Thermal Transient Impedance, Junction-to-Ambient



Normalized Thermal Transient Impedance, Junction-to-Case

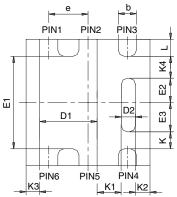
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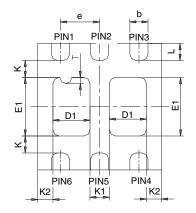




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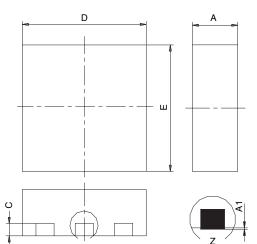
PowerPAK® SC70-6L





BACKSIDE VIEW OF SINGLE

BACKSIDE VIEW OF DUAL



- All dimensions are in millimeters
 Package outline exclusive of mold flash and metal burr
 Package outline inclusive of plating

			SINGL	E PAD						DUAL PAD			
DIM	OIM MILLIMETERS		RS		INCHES		MILLIMETERS			INCHES			
	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	Min	Nom	Max	
Α	0.675	0.75	0.80	0.027	0.030	0.032	0.675	0.75	0.80	0.027	0.030	0.032	
A1	0	-	0.05	0	-	0.002	0	-	0.05	0	-	0.002	
b	0.23	0.30	0.38	0.009	0.012	0.015	0.23	0.30	0.38	0.009	0.012	0.015	
С	0.15	0.20	0.25	0.006	0.008	0.010	0.15	0.20	0.25	0.006	0.008	0.010	
D	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
D1	0.85	0.95	1.05	0.033	0.037	0.041	0.513	0.613	0.713	0.020	0.024	0.028	
D2	0.135	0.235	0.335	0.005	0.009	0.013							
Е	1.98	2.05	2.15	0.078	0.081	0.085	1.98	2.05	2.15	0.078	0.081	0.085	
E1	1.40	1.50	1.60	0.055	0.059	0.063	0.85	0.95	1.05	0.033	0.037	0.041	
E2	0.345	0.395	0.445	0.014	0.016	0.018							
E3	0.425	0.475	0.525	0.017	0.019	0.021							
е		0.65 BSC			0.026 BSC	;	0.65 BSC			0.026 BSC			
K		0.275 TYP	1		0.011 TYP	ı	0.275 TYP 0.011 TYP						
K1	0.400 TYP				0.016 TYP	ı	0.320 TYP 0.013 TYF			0.013 TYP			
K2	0.240 TYP 0.009 TYP			ı	0.252 TYP			0.010 TYP					
К3		0.225 TYP	1	0.009 TYP									
K4		0.355 TYP 0.014 TYP											
L	0.175	0.275	0.375	0.007	0.011	0.015	0.175	0.275	0.375	0.007	0.011	0.015	
Т							0.05	0.10	0.15	0.002	0.004	0.006	
ECNI- C C	7404 D	. 0 00 1	. 07										

DETAIL Z

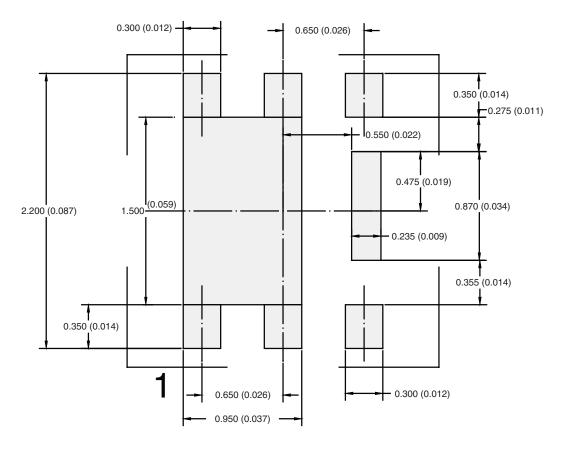
ECN: C-07431 - Rev. C, 06-Aug-07

DWG: 5934

Document Number: 73001 06-Aug-07



RECOMMENDED PAD LAYOUT FOR PowerPAK® SC70-6L Single



Dimensions in mm/(Inches)

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ATTLICATION NOT



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